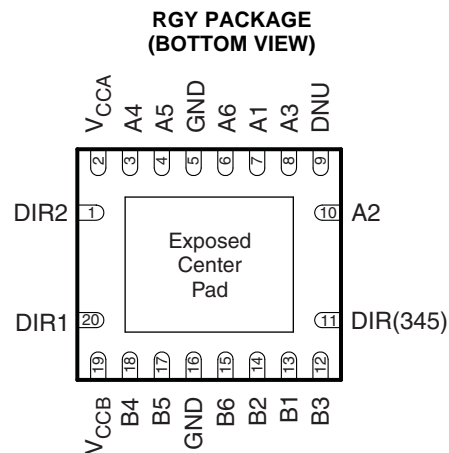
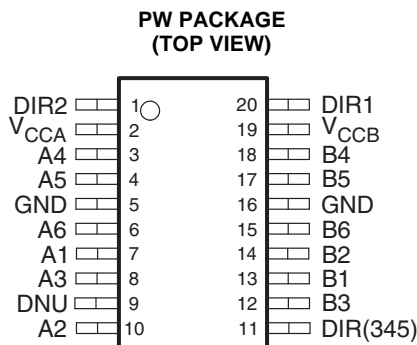


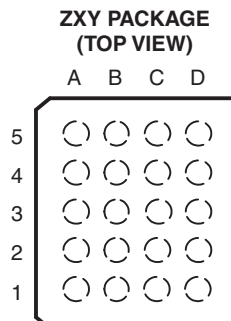
AUDIO CODEC AC'97 VOLTAGE-TRANSLATION TRANSCEIVER

FEATURES

- Voltage-Level Transceiver for Interfacing 1.8 V Audio Codec (AC'97) Controllers With 3.3 V AC'97 Codec Links
- Configurable I/O Switching Levels With Dual-Supply Pins Operating Over Full 1.2-V to 3.6-V Power-Supply Range
- For Low-Power Operation, A and B Ports Are Placed in High-Impedance State When Either Supply Voltage Is Switched Off
- Latch-Up Performance Exceeds 100 mA Per JESD 78, Class II
- ESD Protection Exceeds JESD 22
 - 7000-V Human-Body Model (A114-A)
 - 200-V Machine Model (A115-A)
 - 1500-V Charged-Device Model (C101)



The exposed center pad, if used, must be connected as a secondary ground or left electrically open.



TERMINAL ASSIGNMENTS (20-Ball ZXY Package)

	A	B	C	D
5	V _{CCA}	DIR2	DIR1	V _{CCB}
4	A5	A4	B4	B5
3	A6	GND	GND	B6
2	A3	A1	B2	B1
1	DNU ⁽¹⁾	A2	DIR(345)	B3

(1) DNU – Do not use; should be left unconnected

DESCRIPTION/ORDERING INFORMATION

The SN74AVC6T622 is a voltage-level transceiver for interfacing 1.8 V audio codec (AC'97) controllers, the audio/analog modem functionality found in personal computers, with 3.3V AC'97 codec links. With the digital switching levels of today's AC'97 codecs lowering to 1.8-V logic levels, the SN74AVC6T622 device can be used to bridge the gap between legacy 3.3-V AC'97 codecs and AC'97 controllers that are now operating at 1.8 V. The 6-bit wide SN74AVC6T622 device complies with the AC'97 electrical interface (both levels and timing) specification.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

Two supply-voltage pins allow the A-port and B-port input switching thresholds to be configured separately. The A port is designed to track V_{CCA} , while the B port is designed to track V_{CCB} . V_{CCA} and V_{CCB} can accept any supply voltage from 1.2 V to 3.6 V.

If either V_{CC} is switched off ($V_{CCA} = 0$ V and/or $V_{CCB} = 0$ V), all outputs are placed in the high-impedance state to conserve power.

The SN74AVC6T622 is available in two 0.5-mm-pitch ball grid array (BGA) packages. The 20-ball package has dimensions of 3 mm × 2.5 mm, and the 24-ball package measures 3 mm × 3 mm. Memory cards are widely used in mobile phones, PDAs, digital cameras, personal media players, camcorders, set-top boxes, etc. Low static power consumption and small package size make the SN74AVC6T622 an ideal choice for these applications.

ORDERING INFORMATION

T_A	PACKAGE ⁽¹⁾⁽²⁾		ORDERABLE PART NUMBER	TOP-SIDE MARKING
-40°C to 85°C	QFN – RGY	Reel of 1000	SN74AVC6T622RGYR	WU622
	TSSOP – PW	Reel of 2000	SN74AVC6T622PWR	WU622
	UFBGA – ZXY (Pb-Free)	Reel of 2500	SN74AVC6T622ZXYR	WU622

- (1) Package drawings, thermal data, and symbolization are available at www.ti.com/packaging.
- (2) For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI website at www.ti.com.

REFERENCE DESIGN

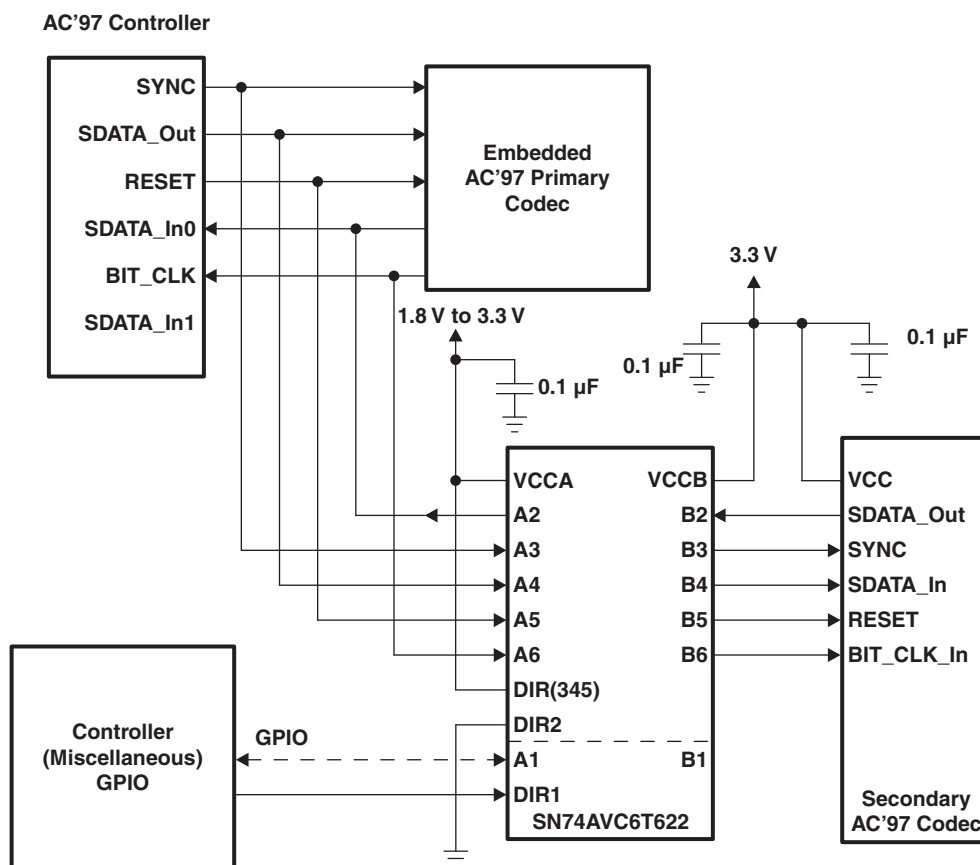


Figure 1. Interfacing 1.8 V AC'97 Controllers With 3.3 V AC'97 Controllers

TERMINAL FUNCTIONS

ZXY BALL NO.	RGY, PW PIN NO.	NAME	TYPE	DESCRIPTION
A1	9	DNU		Do not use; leave unconnected
A2	8	A3	I	AC'97 controller SYNC signal
A3	6	A6	I	AC'97 controller BIT_CLK signal
A4	4	A5	I	AC'97 controller RESET signal
A5	2	V _{CCA}	Pwr	A-port supply voltage. V _{CCA} powers all A-port I/Os and control pins.
B1	10	A2	O	AC'97 controller SDATA_In0 signal
B2	7	A1	I/O	GPIO to miscellaneous GPIO controller
B3, C3	5, 16	GND	–	Ground
B4	3	A4	I	AC'97 controller SDATA_Out signal
B5	1	DIR2	–	Should be tied to GND
C1	11	DIR(345)	–	Should be tied to V _{CCA}
C2	14	B2	I	Secondary AC'97 codec SDATA_Out signal
C4	18	B4	O	Secondary AC'97 codec SDATA_In signal
C5	20	DIR1	I	Direction control from miscellaneous GPIO controller
D1	12	B3	O	Secondary AC'97 codec SYNC signal
D2	13	B1	O	Optional GPIO signal if A1 is enabled
D3	15	B6	O	Secondary AC'97 codec BIT_CLK_In signal
D4	17	B5	O	Secondary AC'97 codec RESET signal
D5	19	V _{CCB}	Pwr	B-port supply voltage. V _{CCB} powers all B-port I/Os and control pins.

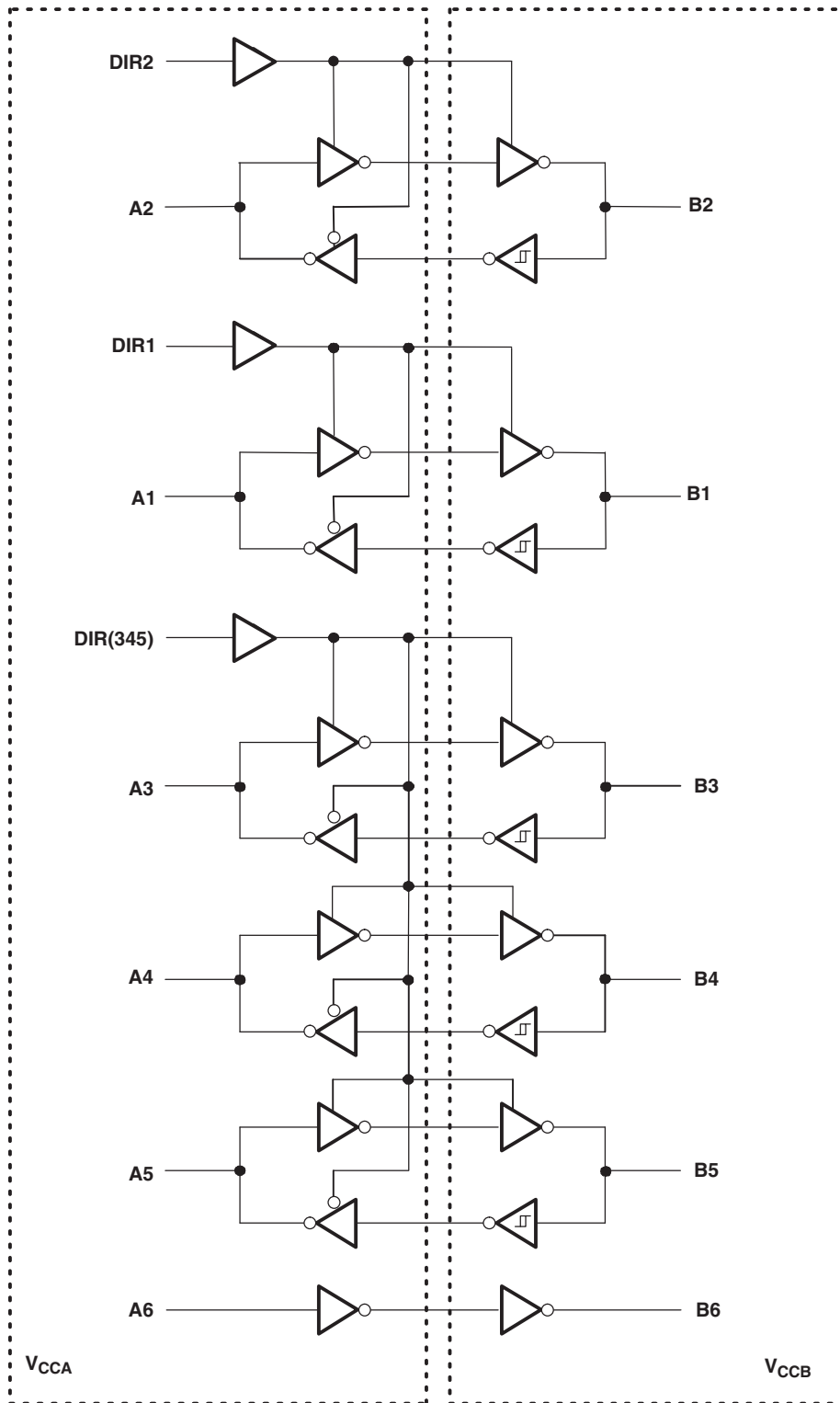
FUNCTION TABLES

CONTROL INPUT DIR2	OUTPUT CIRCUITS		OPERATION
	A2	B2	
High	Hi-Z	Enabled	A2 to B2
Low	Enabled	Hi-Z	B2 to A2

CONTROL INPUT DIR1	OUTPUT CIRCUITS		FUNCTION
	A1	B1	
High	Hi-Z	Enabled	A1 to B1
Low	Enabled	Hi-Z	B1 to A1

CONTROL INPUT DIR(345)	OUTPUT CIRCUITS		FUNCTION
	A3, A4, A5	B3, B4, B5	
High	Hi-Z	Enabled	A3 to B3
			A4 to B4
			A5 to B5
Low	Enabled	Hi-Z	B3 to A3
			B4 to A4
			B5 to A5

LOGIC DIAGRAM (POSITIVE LOGIC)



ABSOLUTE MAXIMUM RATINGS⁽¹⁾

over operating free-air temperature range (unless otherwise noted)

		MIN	MAX	UNIT	
V_{CCA} V_{CCB}	Supply voltage range	–0.5	4.6	V	
V_I	Input voltage range ⁽²⁾	I/O ports (A port)	–0.5	4.6	V
		I/O ports (B port)	–0.5	4.6	
		Control inputs	–0.5	4.6	
V_O	Voltage range applied to any output in the high-impedance or power-off state ⁽²⁾	A port	–0.5	4.6	V
		B port	–0.5	4.6	
V_O	Voltage range applied to any output in the high or low state ⁽²⁾⁽³⁾	A port	–0.5	$V_{CCA} + 0.5$	V
		B port	–0.5	$V_{CCB} + 0.5$	
I_{IK}	Input clamp current	$V_I < 0$	–50	mA	
I_{OK}	Output clamp current	$V_O < 0$	–50	mA	
I_O	Continuous output current		±50	mA	
	Continuous current through V_{CCA} , V_{CCB} , or GND		±100	mA	
θ_{JA}	Package thermal impedance	PW package ⁽⁴⁾	83	°C/W	
		RGY package ⁽⁵⁾	37		
		ZXY package ⁽⁴⁾	193		
T_{stg}	Storage temperature range	–65	150	°C	

- (1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) The input voltage and output negative-voltage ratings may be exceeded if the input and output current ratings are observed.
- (3) The output positive-voltage rating may be exceeded up to 4.6 V maximum if the output current rating is observed.
- (4) The package thermal impedance is calculated in accordance with JESD 51-7.
- (5) The package thermal impedance is calculated in accordance with JESD 51-5.

RECOMMENDED OPERATING CONDITIONS⁽¹⁾⁽²⁾⁽³⁾

		V_{CCI}	V_{CCO}	MIN	MAX	UNIT
V_{CCA}	Supply voltage			1.2	3.6	V
V_{CCB}	Supply voltage			1.2	3.6	V
V_{IH}	High-level input voltage	All inputs ⁽⁴⁾	1.2 V to 1.95 V	$V_{CCI} \times 0.65$		V
			1.95 V to 2.7 V	1.7		
			2.7 V to 3.6 V	2		
V_{IL}	Low-level input voltage	All inputs ⁽⁴⁾	1.2 V to 1.95 V	$V_{CCI} \times 0.35$		V
			1.95 V to 2.7 V	0.7		
			2.7 V to 3.6 V	0.8		
V_I	Input voltage	Control inputs		0	3.6	V
V_{IO}	Input/output voltage	Active state		0	V_{CCO}	V
		3-state		0	3.6	
I_{OH}	High-level output current (A port)		1.2 V	–1		mA
			1.4 V to 1.6 V	–1		
			1.65 V to 1.95 V	–2		
			2.3 V to 2.7 V	–4		
			3 V to 3.6 V	–8		
I_{OL}	Low-level output current (A port)		1.2 V	1		mA
			1.4 V to 1.6 V	1		
			1.65 V to 1.95 V	2		
			2.3 V to 2.7 V	4		
			3 V to 3.6 V	8		
I_{OH}	High-level output current (B port)		1.2 V	–1		mA
			1.4 V to 1.6 V	–2		
			1.65 V to 1.95 V	–4		
			2.3 V to 2.7 V	–8		
			3 V to 3.6 V	–16		
I_{OL}	Low-level output current (B port)		1.2 V	1		mA
			1.4 V to 1.6 V	2		
			1.65 V to 1.95 V	4		
			2.3 V to 2.7 V	8		
			3 V to 3.6 V	16		
$\Delta t/\Delta v$	Input transition rise or fall rate				5	ns/V
T_A	Operating free-air temperature			–40	85	°C

(1) V_{CCI} is the V_{CC} associated with the input port.

(2) V_{CCO} is the V_{CC} associated with the output port.

(3) All unused data inputs of the device must be held at V_{CCI} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

(4) DIR2, DIR1, and DIR(345) are referenced to V_{CCA} .

ELECTRICAL CHARACTERISTICS⁽¹⁾⁽²⁾

over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS		V _{CCA}	V _{CCB}	T _A = 25°C			UNIT
						MIN	TYP ⁽³⁾	MAX	
V _{OH}	A port	I _{OH} = -100 μA	V _I = V _{IH}	1.2 V to 3.6 V	1.2 V to 3.6 V	V _{CCO} - 0.2			V
		I _{OH} = -1 mA		1.2 V	1.2 V	1.1			
		I _{OH} = -2 mA		1.4 V	1.4 V	1.05			
		I _{OH} = -4 mA		1.65 V	1.65 V	1.2			
		I _{OH} = -8 mA		2.3 V	2.3 V	1.75			
		I _{OH} = -8 mA		3 V	3 V	2.3			
V _{OL}	A port	I _{OL} = 100 μA	V _I = V _{IL}	1.2 V to 3.6 V	1.2 V to 3.6 V	0.2			V
		I _{OL} = 1 mA		1.2 V	1.2 V	0.07			
		I _{OL} = 2 mA		1.4 V	1.4 V	0.35			
		I _{OL} = 4 mA		1.65 V	1.65 V	0.45			
		I _{OL} = 8 mA		2.3 V	2.3 V	0.55			
		I _{OL} = 8 mA		3 V	3 V	0.7			
V _{OH}	B port	I _{OH} = -100 μA	V _I = V _{IH}	1.2 V to 3.6 V	1.2 V to 3.6 V	V _{CCO} - 0.2			V
		I _{OH} = -1 mA		1.2 V	1.2 V	1.1			
		I _{OH} = -2 mA		1.4 V	1.4 V	1.05			
		I _{OH} = -4 mA		1.65 V	1.65 V	1.2			
		I _{OH} = -8 mA		2.3 V	2.3 V	1.75			
		I _{OH} = -16 mA		3 V	3 V	2.3			
V _{OL}	B port	I _{OL} = 100 μA	V _I = V _{IL}	1.2 V to 3.6 V	1.2 V to 3.6 V	0.2			V
		I _{OL} = 1 mA		1.2 V	1.2 V	0.07			
		I _{OL} = 2 mA		1.4 V	1.4 V	0.35			
		I _{OL} = 4 mA		1.65 V	1.65 V	0.45			
		I _{OL} = 8 mA		2.3 V	2.3 V	0.55			
		I _{OL} = 16 mA		3 V	3 V	0.7			
I _I	Control inputs	V _I = V _{CCA} or GND		1.2 V to 3.6 V	1.2 V to 3.6 V	±1			μA
I _{off}	A or B port	V _I or V _O = 0 to 3.6 V		0 V	0 V to 3.6 V	±5			μA
				0 V to 3.6 V	0 V	±5			
I _{OZ} ⁽⁴⁾	A or B port	V _O = V _{CCO} or GND, V _I = V _{CCI} or GND	See function table for input states when outputs are Hi Z	3.6 V	3.6 V	±5			μA
I _{CCA}	V _I = V _{CCI} or GND, I _O = 0		1.2 V to 3.6 V		1.2 V to 3.6 V	10			μA
			3.6 V		0 V	10			
			0 V		3.6 V	-1			
I _{CCB}	V _I = V _{CCI} or GND, I _O = 0		1.2 V to 3.6 V		1.2 V to 3.6 V	10			μA
			3.6 V		0 V	-1			
			0 V		3.6 V	10			
I _{CCA} + I _{CCB}	V _I = V _{CCI} or GND, I _O = 0		1.2 V to 3.6 V		1.2 V to 3.6 V	15			μA
C _i	Control inputs	V _I = V _{CCA} or GND		1.8 V	3 V	1.5		2	pF
	Clock input					2			
C _{io}	A port	V _O = V _{CCA} or GND		1.8 V	3 V	2.5		3	pF
	B port	V _O = V _{CCB} or GND				2.5			

(1) V_{CCO} is the V_{CC} associated with the output port.(2) V_{CCI} is the V_{CC} associated with the input port.(3) All typical values are at T_A = 25°C.(4) For I/O ports, the parameter I_{OZ} includes the input leakage current.

OUTPUT SLEW RATES⁽¹⁾

over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	FROM	TO	V _{CCA} = 1.8 V ± 0.15 V, V _{CCB} = 3 V ± 0.3 V		UNIT
			MIN	MAX	
t _r	10%	90%			3 ⁽²⁾ ns
t _f	90%	10%			3 ⁽²⁾ ns

- (1) Values are characterized, but not production tested.
 (2) Using C_L = 15 pF on the B side and C_L = 7 pF on the A side

TYPICAL SWITCHING CHARACTERISTICS

T_A = 25°C, V_{CCA} = 1.2 V (see [Figure 2](#))

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V _{CCB} = 1.2 V	V _{CCB} = 1.5 V	V _{CCB} = 1.8 V	V _{CCB} = 2.5 V	V _{CCB} = 3 V	V _{CCB} = 3.3 V	UNIT
			TYP	TYP	TYP	TYP	TYP	TYP	
t _{pd}	A	B	3.8	3	2.6	2.5	2.5	2.6	ns
	B	A	4.6	4.2	4	3.9	3.9	3.8	
	A6	B6	3.8	3	2.6	2.5	2.5	2.6	
	A2	B2	3.8	3	2.6	2.5	2.5	2.6	
	B2	A2	4.6	4.2	4	3.9	3.9	3.8	
t _{en} ⁽¹⁾	DIR	B	4.8	4	3.7	3.4	3.4	3.4	ns
		A	4.5	4.4	5	5.4	5.4	5.4	
t _{dis} ⁽¹⁾	DIR	B	6.3	5.2	5.6	4.8	4.8	6.1	ns
		A	4.8	4.6	5.3	5.4	5.4	5.3	

- (1) DIR refers to DIR2, DIR1, and DIR(345).

SWITCHING CHARACTERISTICS

over recommended operating free-air temperature range, V_{CCA} = 1.5 V ± 0.1 V (see [Figure 2](#))

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V _{CCB} = 1.2 V	V _{CCB} = 1.5 V ± 0.1 V		V _{CCB} = 1.8 V ± 0.15 V		V _{CCB} = 2.5 V ± 0.2 V		V _{CCB} = 3 V ± 0.3 V		V _{CCB} = 3.3 V ± 0.3 V		UNIT
			TYP	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
t _{pd}	A	B	3.4	1.1	5.6	1	4.8	1	3.9	0.9	3.9	0.9	3.8	ns
	B	A	3.8	1.4	6	1.3	5.6	1.3	5.2	0.5	5.2	0.3	5.2	
	A6	B6	3.4	1.1	5.6	1	4.8	1	3.9	0.9	3.9	0.9	3.8	
	A2	B2	3.4	1.1	5.6	1	4.8	1	3.9	0.9	3.9	0.9	3.8	
	B2	A2	3.8	1.4	6	1.3	5.6	1.3	5.2	0.5	5.2	0.3	5.2	
t _{en} ⁽¹⁾	DIR	B	4	1.3	7.7	1.1	6.9	0.8	6.1	0.8	6	0.8	5.9	ns
		A	3.5	1.4	7	1.5	7.4	1.7	8.2	1.7	8.2	1.7	7.7	
t _{dis} ⁽¹⁾	DIR	B	5.7	1.9	8.9	2.1	10.4	1.8	8.7	1.7	8.5	2.4	11.4	ns
		A	3.4	1.2	7	1.2	6.8	1.2	6.9	1.2	6.5	1.2	6.6	

- (1) DIR refers to DIR2, DIR1, and DIR(345).

SWITCHING CHARACTERISTICS

over recommended operating free-air temperature range, $V_{CCA} = 1.8 \text{ V} \pm 0.15 \text{ V}$ (see [Figure 2](#))

PARAMETER	FROM (INPUT)	TO (OUTPUT)	$V_{CCB} = 1.2 \text{ V}$	$V_{CCB} = 1.5 \text{ V} \pm 0.1 \text{ V}$		$V_{CCB} = 1.8 \text{ V} \pm 0.15 \text{ V}$		$V_{CCB} = 2.5 \text{ V} \pm 0.2 \text{ V}$		$V_{CCB} = 3 \text{ V} \pm 0.3 \text{ V}$		$V_{CCB} = 3.3 \text{ V} \pm 0.3 \text{ V}$		UNIT
			TYP	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
t_{pd}	A	B	3.2	1	5.2	0.8	4.4	0.7	3.5	0.6	3.4	0.7	3.1	ns
	B	A	3.4	1.1	5.2	1	4.8	0.9	4.3	0.3	4.3	0.2	4.3	
	A6	B6	3.2	1	5.2	0.8	4.4	0.7	3.5	0.6	3.4	0.7	3.1	
	A2	B2	3.2	1	5.2	0.8	4.4	0.7	3.5	0.6	3.4	0.7	3.1	
	B2	A2	3.4	1.1	5.2	1	4.8	0.9	4.3	0.3	4.3	0.2	4.3	
$t_{en}^{(1)}$	DIR	B	3.5	1.2	6.8	0.9	6	0.7	5.1	0.7	5	0.7	4.8	ns
		A	2.9	1.1	4.7	1.1	5.2	1.4	5.1	1.4	5.1	1.4	5.3	
$t_{dis}^{(1)}$	DIR	B	5.3	1.6	8.4	2	9.5	1.6	8.2	1.4	8.1	2.2	8.2	ns
		A	3.6	1.3	7.7	1.2	7.9	1.3	7.5	1.3	7.5	1.3	7.6	

(1) DIR refers to DIR2, DIR1, and DIR(345).

SWITCHING CHARACTERISTICS

over recommended operating free-air temperature range, $V_{CCA} = 2.5 \text{ V} \pm 0.2 \text{ V}$ (see [Figure 2](#))

PARAMETER	FROM (INPUT)	TO (OUTPUT)	$V_{CCB} = 1.2 \text{ V}$	$V_{CCB} = 1.5 \text{ V} \pm 0.1 \text{ V}$		$V_{CCB} = 1.8 \text{ V} \pm 0.15 \text{ V}$		$V_{CCB} = 2.5 \text{ V} \pm 0.2 \text{ V}$		$V_{CCB} = 3 \text{ V} \pm 0.3 \text{ V}$		$V_{CCB} = 3.3 \text{ V} \pm 0.3 \text{ V}$		UNIT
			TYP	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
t_{pd}	A	B	3	0.8	4.7	0.7	3.8	0.6	2.9	0.4	2.7	0.5	2.5	ns
	B	A	3	0.9	4.4	0.7	3.9	0.6	3.3	0.3	3.2	0.3	3.2	
	A6	B6	3	0.8	4.7	0.7	3.8	0.6	2.9	0.4	2.7	0.5	2.5	
	A2	B2	3	0.8	4.7	0.7	3.8	0.6	2.9	0.4	2.7	0.5	2.5	
	B2	A2	3	0.9	4.4	0.7	3.9	0.6	3.3	0.3	3.2	0.3	3.2	
$t_{en}^{(1)}$	DIR	B	3.1	1	5.7	0.8	4.8	0.5	3.9	0.5	3.7	0.5	3.6	ns
		A	2.2	0.7	3.5	0.6	4.3	1.2	4.4	0.7	4.6	0.4	4.7	
t_{dis}	DIR	B	4.6	1.4	7.6	1.8	8.4	1.3	7.2	1.3	7.1	2	7.5	ns
		A	2.6	0.9	5.6	0.9	5.4	1	5.5	0.9	5.5	0.9	5.8	

(1) DIR refers to DIR2, DIR1, and DIR(345).

SWITCHING CHARACTERISTICS

 over recommended operating free-air temperature range, $V_{CCA} = 3.3 \text{ V} \pm 0.3 \text{ V}$ (see [Figure 2](#))

PARAMETER	FROM (INPUT)	TO (OUTPUT)	$V_{CCB} = 1.2 \text{ V}$	$V_{CCB} = 1.5 \text{ V} \pm 0.1 \text{ V}$		$V_{CCB} = 1.8 \text{ V} \pm 0.15 \text{ V}$		$V_{CCB} = 2.5 \text{ V} \pm 0.2 \text{ V}$		$V_{CCB} = 3 \text{ V} \pm 0.3 \text{ V}$		$V_{CCB} = 3.3 \text{ V} \pm 0.3 \text{ V}$		UNIT	
			TYP	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX		
t_{pd}	A	B	2.8	0.8	4.5	0.6	3.6	0.4	2.7	0.4	2.7	0.3	2.3	ns	
		A	2.9	0.8	4.3	0.6	3.7	0.5	3	0.5	3	0.1	2.7		
		A6	B6	2.8	0.8	4.5	0.6	3.6	0.4	2.7	0.4	2.7	0.3		2.3
		A2	B2	2.8	0.8	4.5	0.6	3.6	0.4	2.7	0.4	2.7	0.3		2.3
		B2	A2	2.9	0.8	4.3	0.6	3.7	0.5	3	0.5	3	0.1		2.7
$t_{en}^{(1)}$	DIR	B	3	1	5.1	0.6	4.3	0.5	3.4	0.5	3.4	0.4	3	ns	
		A	2	0.6	3.1	0.6	5.4	0.7	5.4	0.7	5.4	0.5	5.4		
$t_{dis}^{(1)}$	DIR	B	4.4	1.4	7.4	1.8	8.3	1.2	7	1.2	7	2	7.3	ns	
		A	3.7	1.5	8.1	1.5	7.9	1.5	7.9	1.5	7.9	1.5	8		

(1) DIR refers to DIR2, DIR1, and DIR(345).

TYPICAL FREQUENCY AND OUTPUT SKEW

 $T_A = 25^\circ\text{C}$, $V_{CCA} = 1.2 \text{ V}$ (see [Figure 2](#))

PARAMETER	FROM (INPUT)	TO (OUTPUT)	$V_{CCB} = 1.2 \text{ V}$	$V_{CCB} = 1.5 \text{ V}$	$V_{CCB} = 1.8 \text{ V}$	$V_{CCB} = 2.5 \text{ V}$	$V_{CCB} = 3 \text{ V}$	$V_{CCB} = 3.3 \text{ V}$	UNIT	
			TYP	TYP	TYP	TYP	TYP	TYP		
t_{max}	Clock	A6	B6	95	95	95	95	95	MHz	
		Data	A	B	95	95	95	95		
			B	A	95	95	95	95		
$t_{sk(o)}$	Channel-to-channel	A	B	0.5	0.4	0.4	0.3	0.5	0.5	ns

MAXIMUM FREQUENCY AND OUTPUT SKEW

 over recommended operating free-air temperature range, $V_{CCA} = 1.5 \text{ V} \pm 0.1 \text{ V}$ (see [Figure 2](#))

PARAMETER	FROM (INPUT)	TO (OUTPUT)	$V_{CCB} = 1.2 \text{ V}$	$V_{CCB} = 1.5 \text{ V} \pm 0.1 \text{ V}$		$V_{CCB} = 1.8 \text{ V} \pm 0.15 \text{ V}$		$V_{CCB} = 2.5 \text{ V} \pm 0.2 \text{ V}$		$V_{CCB} = 3 \text{ V} \pm 0.3 \text{ V}$		$V_{CCB} = 3.3 \text{ V} \pm 0.3 \text{ V}$		UNIT
			TYP	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
f_{max}	Clock	A6	B6	95	95	95	95	95	95	95	95	95	95	MHz
		Data	A	B	95	95	95	95	95	95	95	95	95	
			B	A	95	95	95	95	95	95	95	95	95	
$t_{sk(o)}$	Channel-to-channel	DIR	B	0.3	0.3	0.3	0.3	0.3	0.5	0.4	0.4	0.4	ns	

MAXIMUM FREQUENCY AND OUTPUT SKEW

 over recommended operating free-air temperature range, $V_{CCA} = 1.8 \text{ V} \pm 0.15 \text{ V}$ (see [Figure 2](#))

PARAMETER	FROM (INPUT)	TO (OUTPUT)	$V_{CCB} = 1.2 \text{ V}$	$V_{CCB} = 1.5 \text{ V} \pm 0.1 \text{ V}$		$V_{CCB} = 1.8 \text{ V} \pm 0.15 \text{ V}$		$V_{CCB} = 2.5 \text{ V} \pm 0.2 \text{ V}$		$V_{CCB} = 3 \text{ V} \pm 0.3 \text{ V}$		$V_{CCB} = 3.3 \text{ V} \pm 0.3 \text{ V}$		UNIT
			TYP	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
f_{max}	Clock	A6	B6	95	95	95	95	95	95	95	95	95	95	MHz
		Data	A	B	95	95	95	95	95	95	95	95	95	
			B	A	95	95	95	95	95	95	95	95	95	
$t_{sk(o)}$	Channel-to-channel	DIR	B	0.3	0.3	0.3	0.3	0.3	0.5	0.3	0.3	0.3	ns	

MAXIMUM FREQUENCY AND OUTPUT SKEW

over recommended operating free-air temperature range, $V_{CCA} = 2.5 \text{ V} \pm 0.2 \text{ V}$ (see [Figure 2](#))

PARAMETER	FROM (INPUT)	TO (OUTPUT)	$V_{CCB} = 1.2 \text{ V}$	$V_{CCB} = 1.5 \text{ V} \pm 0.1 \text{ V}$		$V_{CCB} = 1.8 \text{ V} \pm 0.15 \text{ V}$		$V_{CCB} = 2.5 \text{ V} \pm 0.2 \text{ V}$		$V_{CCB} = 3 \text{ V} \pm 0.3 \text{ V}$		$V_{CCB} = 3.3 \text{ V} \pm 0.3 \text{ V}$		UNIT
			TYP	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
f_{max}	Clock	A6	B6	95	95	95	95	95	95	95	95	95	MHz	
	Data	A	B	95	95	95	95	95	95	95	95	95		
		B	A	95	95	95	95	95	95	95	95	95		
$t_{\text{sk(o)}}$	Channel-to-channel	DIR	B	0.3	0.3	0.3	0.2	0.6	0.3	ns				

MAXIMUM FREQUENCY AND OUTPUT SKEW

over recommended operating free-air temperature range, $V_{CCA} = 3.3 \text{ V} \pm 0.3 \text{ V}$ (see [Figure 2](#))

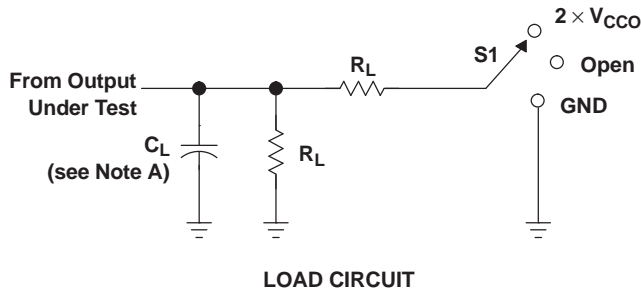
PARAMETER	FROM (INPUT)	TO (OUTPUT)	$V_{CCB} = 1.2 \text{ V}$	$V_{CCB} = 1.5 \text{ V} \pm 0.1 \text{ V}$		$V_{CCB} = 1.8 \text{ V} \pm 0.15 \text{ V}$		$V_{CCB} = 2.5 \text{ V} \pm 0.2 \text{ V}$		$V_{CCB} = 3 \text{ V} \pm 0.3 \text{ V}$		$V_{CCB} = 3.3 \text{ V} \pm 0.3 \text{ V}$		UNIT
			TYP	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
f_{max}	Clock	A6	B6	95	95	95	95	95	95	95	95	MHz		
	Data	A	B	95	95	95	95	95	95	95	95			
		B	A	95	95	95	95	95	95	95	95			
$t_{\text{sk(o)}}$	Channel-to-channel	DIR	B	0.3	0.3	0.4	0.3	0.6	0.4	ns				

OPERATING CHARACTERISTICS
 $T_A = 25^\circ\text{C}$

PARAMETER		TEST CONDITIONS	$V_{CCA} =$ $V_{CCB} = 1.2\text{ V}$	$V_{CCA} =$ $V_{CCB} = 1.5\text{ V}$	$V_{CCA} =$ $V_{CCB} = 1.8\text{ V}$	$V_{CCA} =$ $V_{CCB} = 2.5\text{ V}$	$V_{CCA} =$ $V_{CCB} = 3\text{ V}$	$V_{CCA} =$ $V_{CCB} = 3.3\text{ V}$	UNIT
			TYP	TYP	TYP	TYP	TYP	TYP	
$C_{pdA}^{(1)}$	A-port input, B-port output	$C_L = 0,$ $f = 10\text{ MHz},$ $t_r = t_f = 1\text{ ns}$	1.9	2	2.1	2.4	2.7	2.9	pF
	B-port input, A-port output		4.4	4.5	4.6	4.7	4.8	4.9	
$C_{pdB}^{(1)}$	A-port input, B-port output	$C_L = 0,$ $f = 10\text{ MHz},$ $t_r = t_f = 1\text{ ns}$	5.3	5.4	5.4	5.7	5.8	5.9	pF
	B-port input, A-port output		0.3	0.3	0.4	0.5	0.6	0.6	

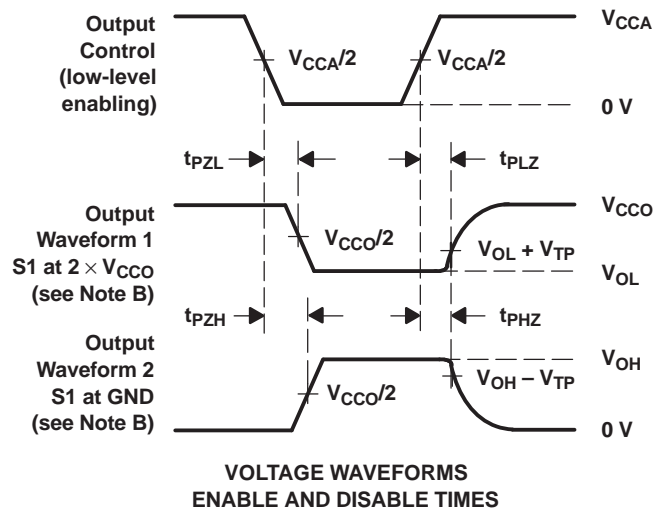
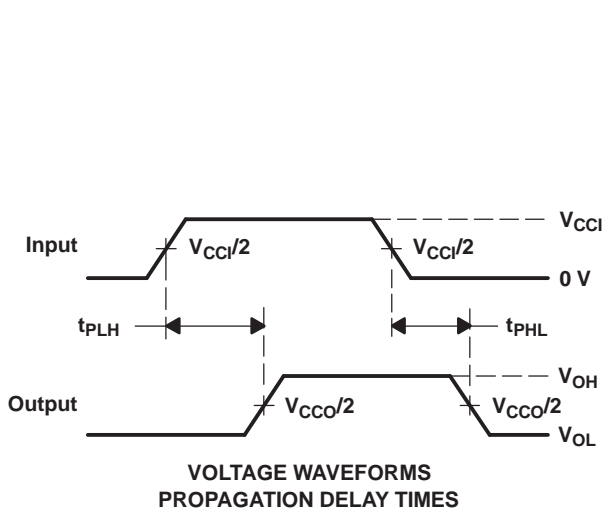
(1) Power dissipation capacitance per transceiver

PARAMETER MEASUREMENT INFORMATION



TEST	S1
t_{pd}	Open
t_{PLZ}/t_{PZL}	$2 \times V_{CCO}$
t_{PHZ}/t_{PZH}	GND



V_{CCO}	C_L	R_L	V_{TP}
$1.5\text{ V} \pm 0.1\text{ V}$	15 pF	2 k Ω	0.1 V
$1.8\text{ V} \pm 0.15\text{ V}$	15 pF	2 k Ω	0.15 V
$2.5\text{ V} \pm 0.2\text{ V}$	15 pF	2 k Ω	0.15 V
$3.3\text{ V} \pm 0.3\text{ V}$	15 pF	2 k Ω	0.3 V



- NOTES:
- A. C_L includes probe and jig capacitance.
 - B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
 - C. All input pulses are supplied by generators having the following characteristics: $PRR \leq 10\text{ MHz}$, $Z_O = 50\ \Omega$, $dv/dt \geq 1\text{ V/ns}$.
 - D. The outputs are measured one at a time, with one transition per measurement.
 - E. t_{PLZ} and t_{PHZ} are the same as t_{dis} .
 - F. t_{PZL} and t_{PZH} are the same as t_{en} .
 - G. t_{PLH} and t_{PHL} are the same as t_{pd} .
 - H. V_{CCI} is the V_{CC} associated with the input port.
 - I. V_{CCO} is the V_{CC} associated with the output port.

Figure 2. Load Circuit and Voltage Waveforms

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
SN74AVC6T622PWR	ACTIVE	TSSOP	PW	20	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	WU622	
SN74AVC6T622RGYR	ACTIVE	VQFN	RGY	20	3000	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR	-40 to 85	WU622	

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

Important Information and Disclaimer:The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

TAPE AND REEL INFORMATION

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE


*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74AVC6T622PWR	TSSOP	PW	20	2000	330.0	16.4	6.95	7.1	1.6	8.0	16.0	Q1
SN74AVC6T622RGYR	VQFN	RGY	20	3000	330.0	12.4	3.8	4.8	1.6	8.0	12.0	Q1

TAPE AND REEL BOX DIMENSIONS


*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74AVC6T622PWR	TSSOP	PW	20	2000	356.0	356.0	35.0
SN74AVC6T622RGYR	VQFN	RGY	20	3000	356.0	356.0	35.0

GENERIC PACKAGE VIEW

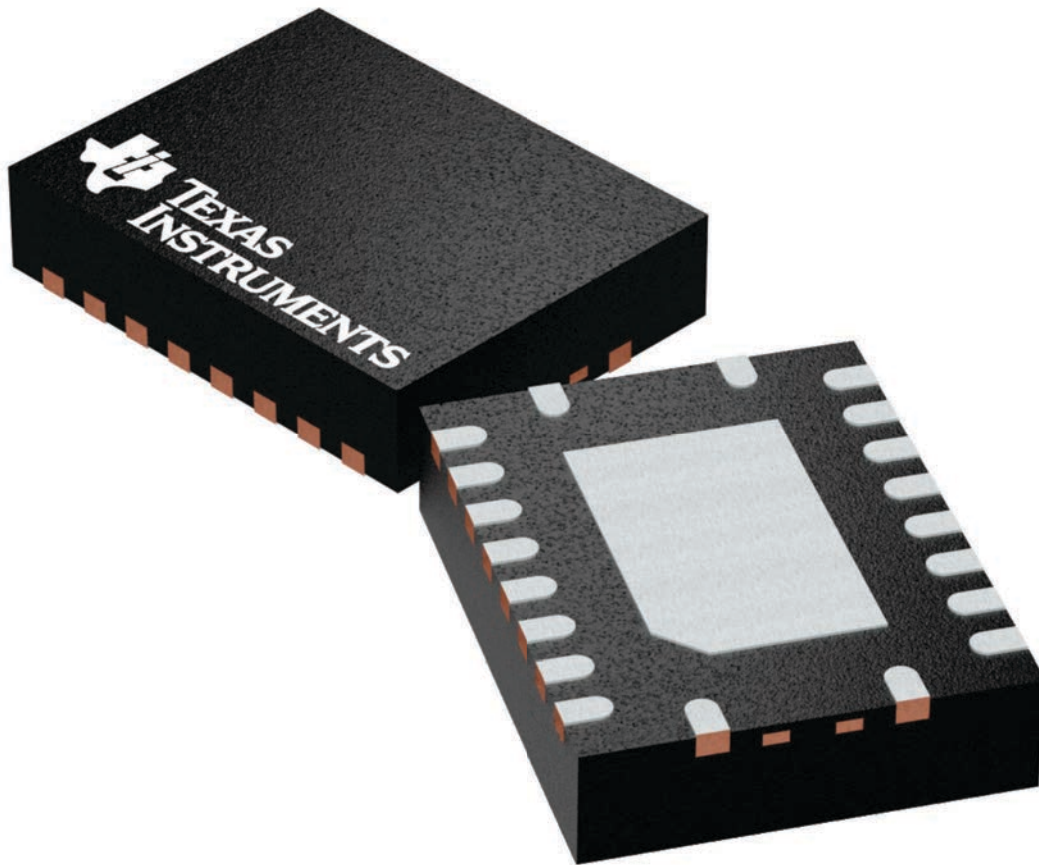
RGY 20

VQFN - 1 mm max height

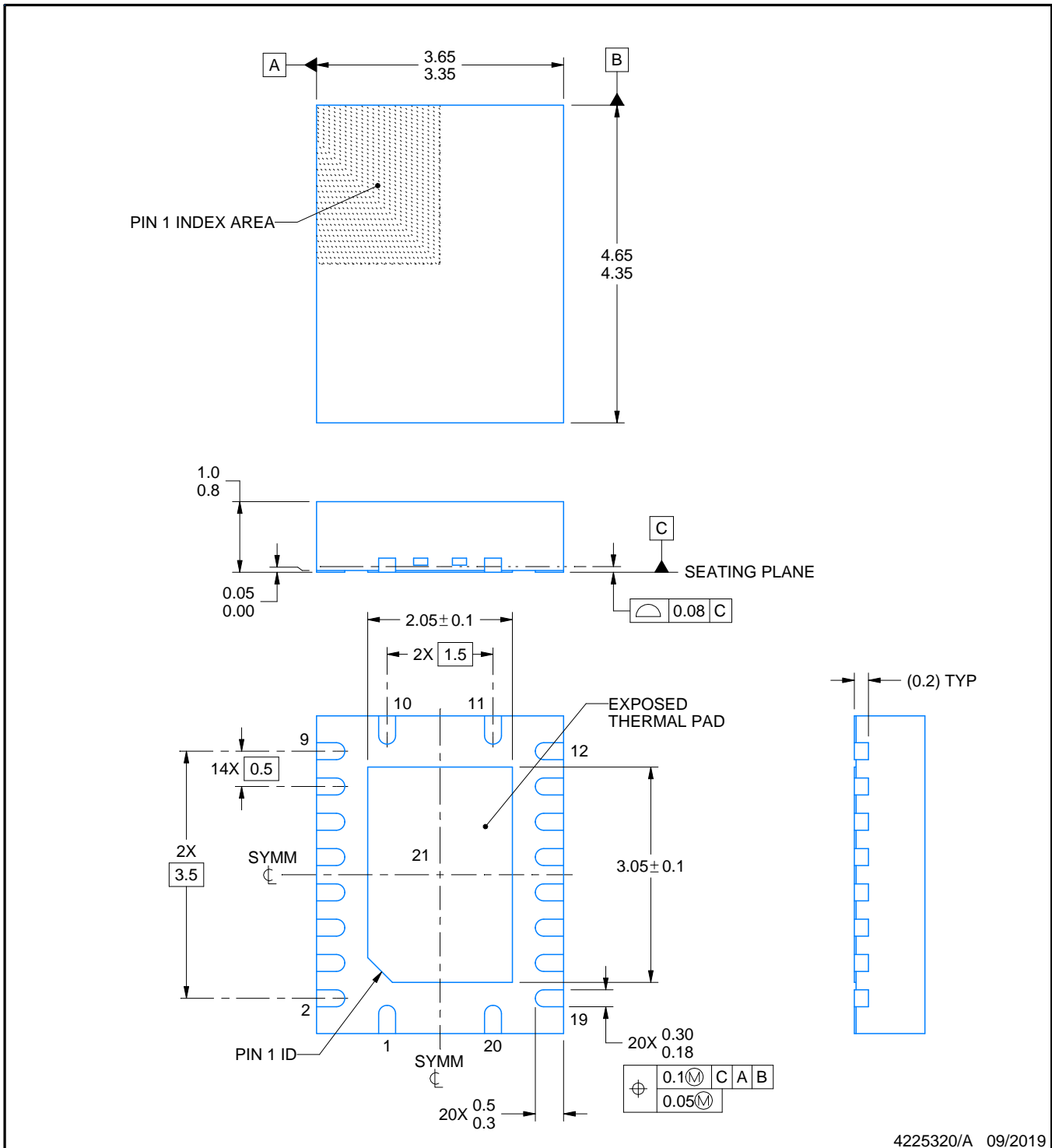
3.5 x 4.5, 0.5 mm pitch

PLASTIC QUAD FGLATPACK - NO LEAD

This image is a representation of the package family, actual package may vary.
Refer to the product data sheet for package details.



4225264/A



4225320/A 09/2019

NOTES:

1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. The package thermal pad must be soldered to the printed circuit board for thermal and mechanical performance.

EXAMPLE BOARD LAYOUT

RGY0020A

VQFN - 1 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



LAND PATTERN EXAMPLE
EXPOSED METAL SHOWN
SCALE:18X



SOLDER MASK DETAILS

4225320/A 09/2019

NOTES: (continued)

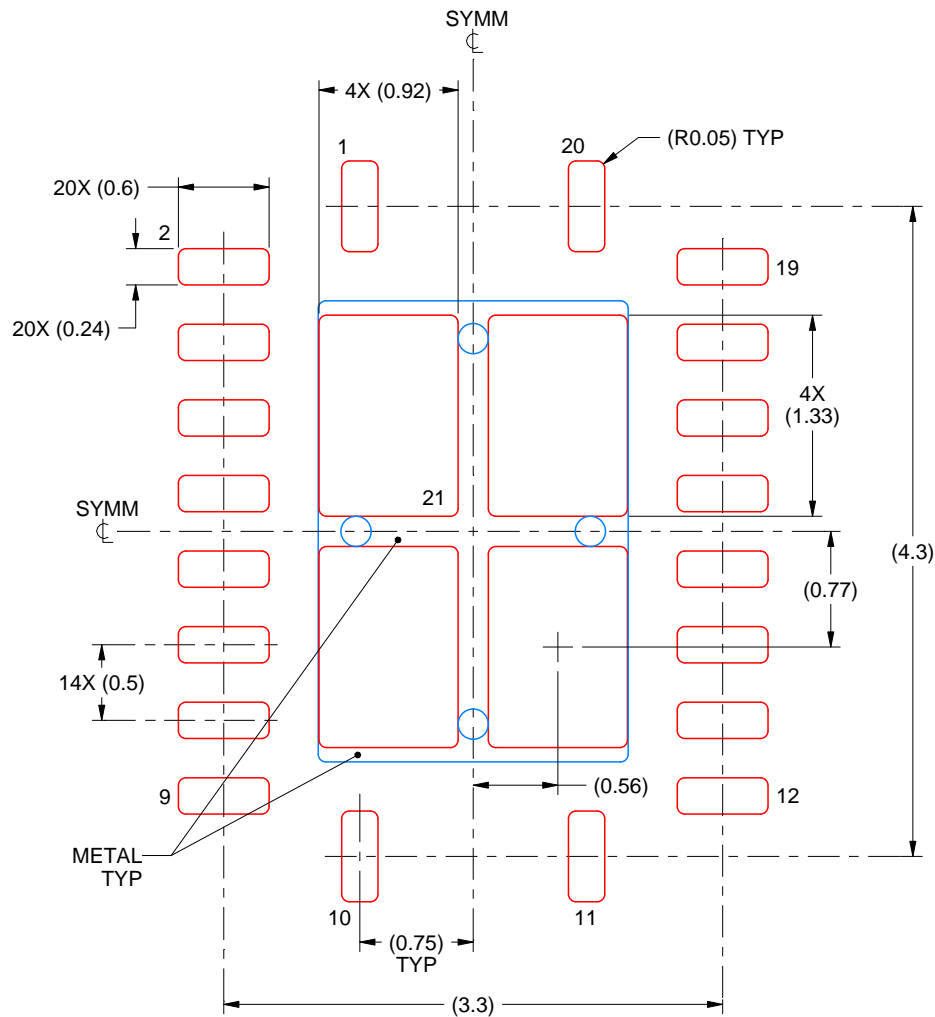
- This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature number SLUA271 (www.ti.com/lit/slua271).
- Vias are optional depending on application, refer to device data sheet. If any vias are implemented, refer to their locations shown on this view. It is recommended that vias under paste be filled, plugged or tented.

EXAMPLE STENCIL DESIGN

RGY0020A

VQFN - 1 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



SOLDER PASTE EXAMPLE
BASED ON 0.125 mm THICK STENCIL

EXPOSED PAD 21
78% PRINTED SOLDER COVERAGE BY AREA UNDER PACKAGE
SCALE:20X

4225320/A 09/2019

NOTES: (continued)

6. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

PW0020A



PACKAGE OUTLINE

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



4220206/A 02/2017

NOTES:

- All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
- This drawing is subject to change without notice.
- This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm per side.
- This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm per side.
- Reference JEDEC registration MO-153.

EXAMPLE BOARD LAYOUT

PW0020A

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



LAND PATTERN EXAMPLE
EXPOSED METAL SHOWN
SCALE: 10X



SOLDER MASK DETAILS

4220206/A 02/2017

NOTES: (continued)

- 6. Publication IPC-7351 may have alternate designs.
- 7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

EXAMPLE STENCIL DESIGN

PW0020A

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



SOLDER PASTE EXAMPLE
BASED ON 0.125 mm THICK STENCIL
SCALE: 10X

4220206/A 02/2017

NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

PW (R-PDSO-G20)

PLASTIC SMALL OUTLINE



- NOTES:
- A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. Publication IPC-7351 is recommended for alternate design.
 - D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
 - E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.

IMPORTANT NOTICE AND DISCLAIMER

TI PROVIDES TECHNICAL AND RELIABILITY DATA (INCLUDING DATA SHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS AND IMPLIED, INCLUDING WITHOUT LIMITATION ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for skilled developers designing with TI products. You are solely responsible for (1) selecting the appropriate TI products for your application, (2) designing, validating and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, regulatory or other requirements.

These resources are subject to change without notice. TI grants you permission to use these resources only for development of an application that uses the TI products described in the resource. Other reproduction and display of these resources is prohibited. No license is granted to any other TI intellectual property right or to any third party intellectual property right. TI disclaims responsibility for, and you will fully indemnify TI and its representatives against, any claims, damages, costs, losses, and liabilities arising out of your use of these resources.

TI's products are provided subject to [TI's Terms of Sale](#) or other applicable terms available either on ti.com or provided in conjunction with such TI products. TI's provision of these resources does not expand or otherwise alter TI's applicable warranties or warranty disclaimers for TI products.

TI objects to and rejects any additional or different terms you may have proposed.

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265
Copyright © 2022, Texas Instruments Incorporated